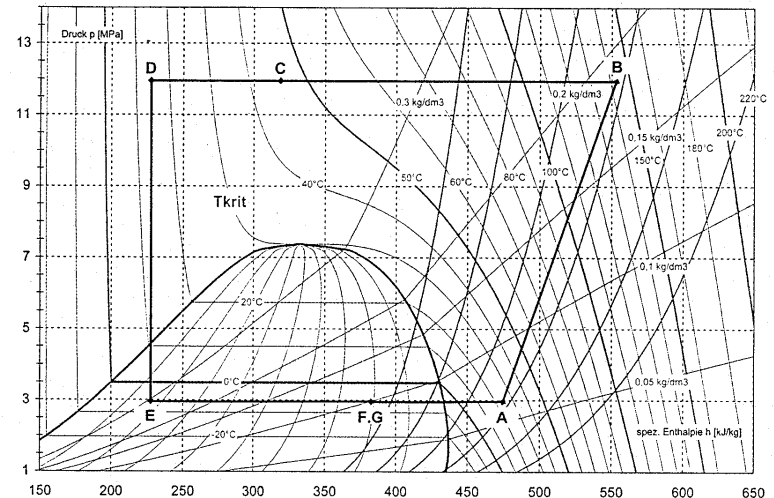
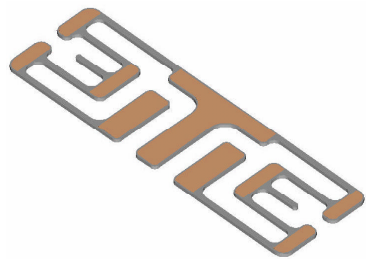


PRESSURE CONTROLS FOR R744 CLIMATE CONTROL SYSTEMS



INTRODUCTION

Observations In Auto A/C

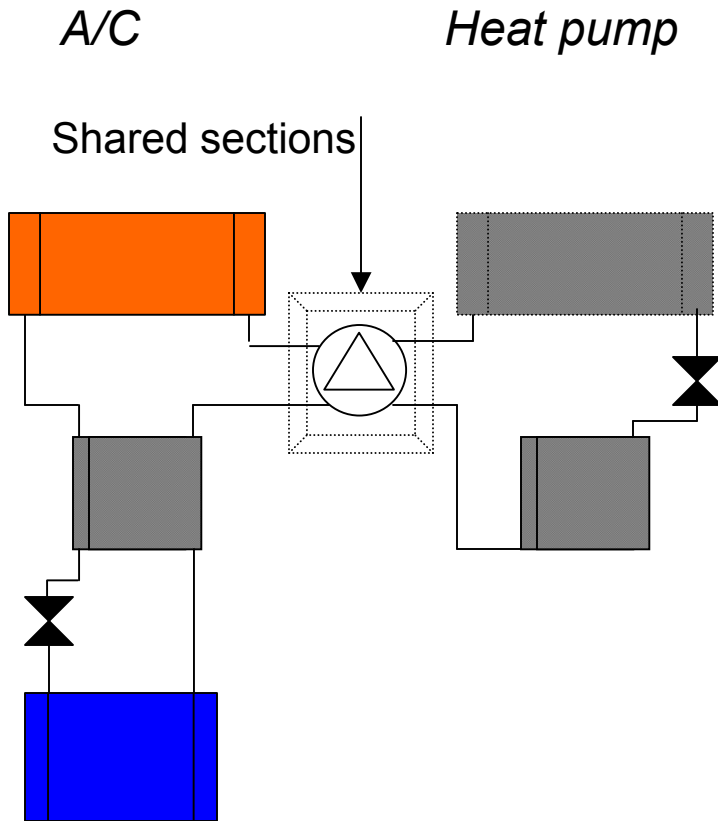
- Automotive Industry Searching For Alternative Refrigerants
- New Functionalities Are Added
- System Control More Complicated

INTRODUCTION

Consequences For Sensors

- Requirements Trend Up
 - Introduction Under Severe Cost Pressure
- Suppliers contribution to enable introduction in cost and innovation

MOUNTING POSITION CONTROLS



- Heat pump capability limits sensor mounting flexibility
- Mounting position drives specifications
- Pressure and temperature used for A/C & heat pump control

Therefore:

- I. Integration Of Pressure And Temperature Sensor
- II. To Maintain Flexibility, All Mounting Positions Must Be Possible

CONSEQUENCES MOUNTING POSITION R134a SYSTEM vs R744 SYSTEM

Pressure Control Requirements				
		R134a	R744	
		high side liquid	discharge	
Pressure		30..35	120 .. 160	[bar]
Temperature	<i>Medium</i>	80	180	[°C]
	<i>Ambient</i>	125	125	[°C]
Mol Mass		102	44	[u]

ALTERNATIVE TECHNOLOGIES

- MEMS P+T
 - Die attach / Bondwires exposed to 180°C, dynamic gas flow
 - Trade off between reliability (out-of-stream) and signal accuracy (into stream)
- Ceramic P+T
 - Elastomer seal
 - + Production Experience
- Discrete Silicon Strain Gauge
 - + High temperature capability
 - + Capability to separate SE and Conditioning Electronics
 - + Production Experience
 - + P&T Sensitivity
 - + Cost

MSG PRESSURE SENSOR

Base Technology

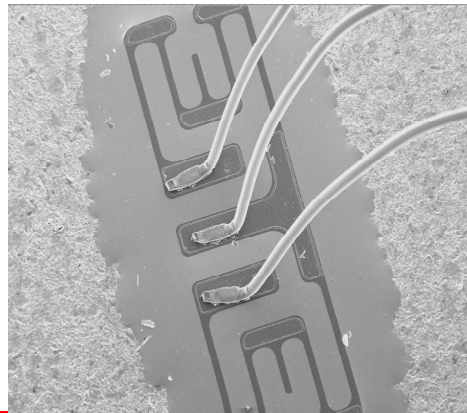
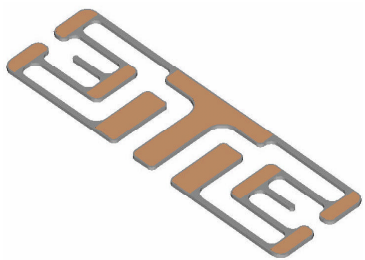
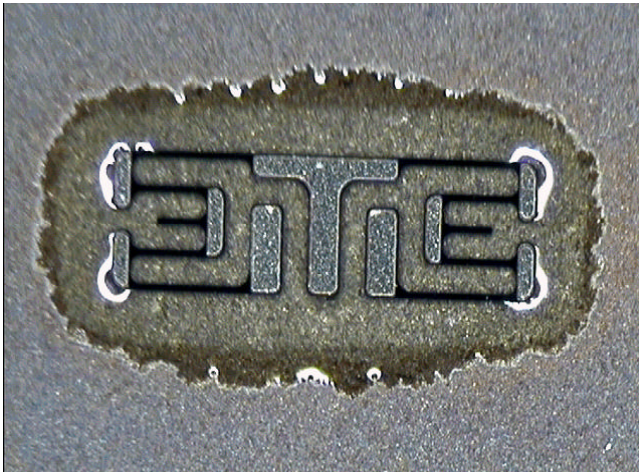
Micro Fused Strain Gage

Design Assumptions:

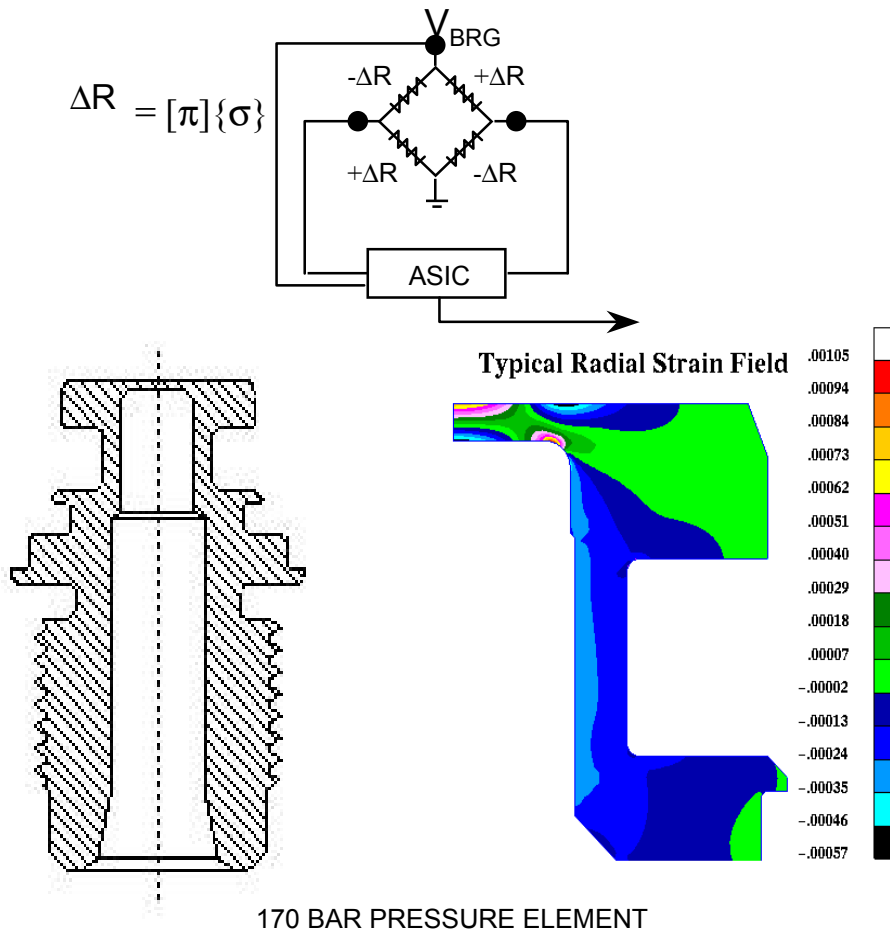
- ✓ Hermetic Pressure Sensor (Metal 1 piece / weld)
- ✓ High Volume Manufacturability Against Minimized Cost
- ✓ Modular Build For Configuration Flexibility
- ✓ Temperature Compensated (Extreme Temperature Span)
- ✓ <2%FS Error Band (for Pressure Control)
- ✓ Diagnostics (Safety)
- ✓ High Proof/Burst Capabilities

SILICON SENSING ELEMENT

- Mono crystalline silicon gages fabricated with standard semiconductor processes
- Gage geometry defined in DRIE process. Minimizes geometry variation
- Aluminum metallization
- Standard glass bonding process attaches gages to element
- 0.5 mm x 1.5 mm x 10 μm



SENSOR DEVELOPMENT



- FEA guides sense element geometry
- Regions of tensile and compressive surface stress set-up full Wheatstone bridge
- Port material: 17-4PH stainless steel
- Strain gages are glass bonded over appropriate local stress field
- At full scale pressure $s_{\max}/s_Y = 0.2$.

PT SENSOR FOR R744

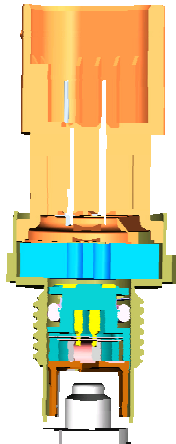
Target:

Integration of pressure sensor and intrusive temperature sensor

- Use existing sensing elements / electronics → cost target €3 D
- In-flow sensing elements
- Response time & accuracy
 - ~ second(s)
 - $\pm 5^{\circ}\text{C}$, target $\pm 3^{\circ}\text{C}$ (...)

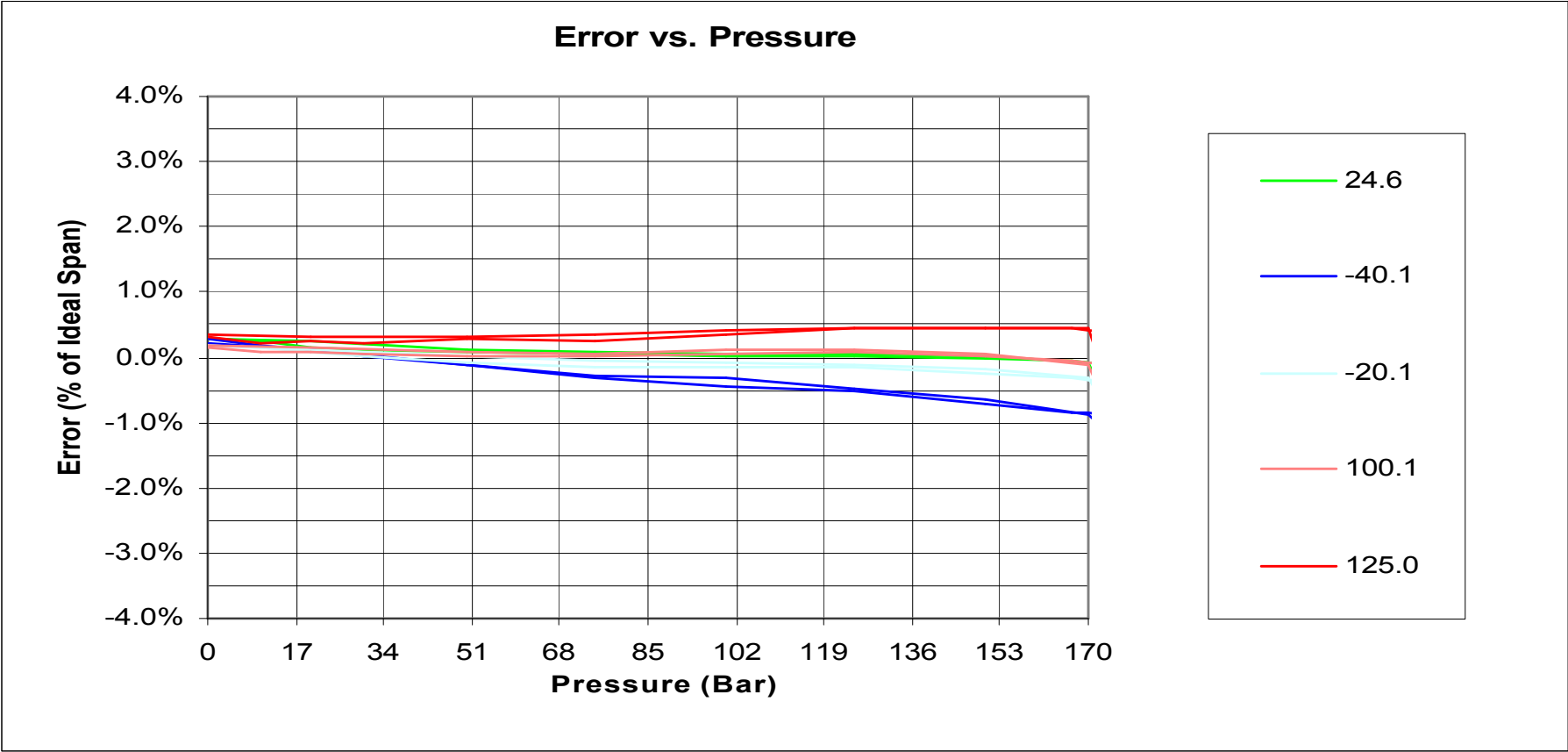
- Thermal Rules
 - Sensing Elements Exposed To Gas Temperatures
 - Conditioning Electronics Thermally Insulated

MSG – R744 A/C PT SENSORS



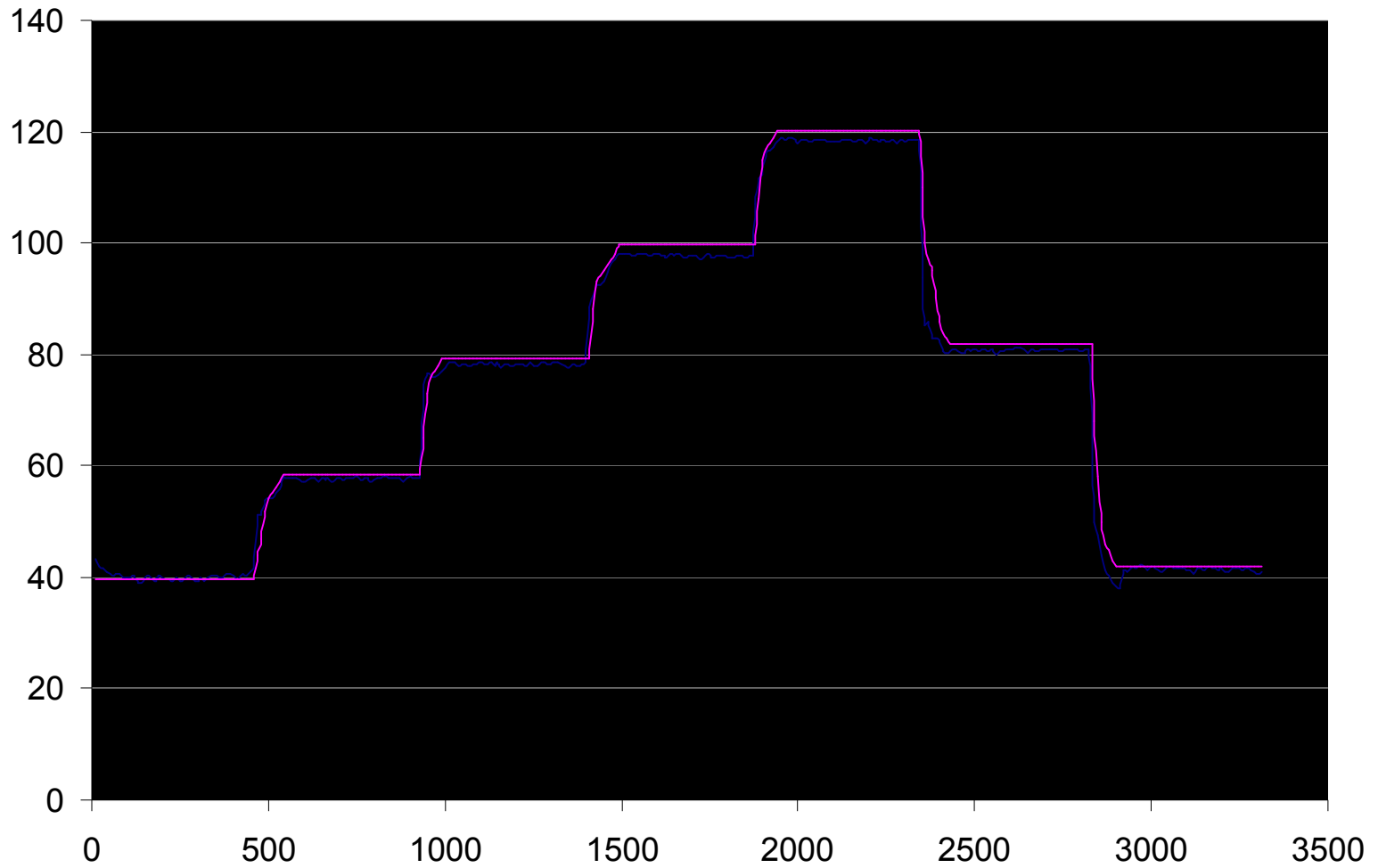
- P/T MSG
 - hermetic design
 - should enable fast T response and acceptable T- accuracy
- 3rd Generation PT Design IN PROTO STAGE
 - 1st generation = Brake Pressure 67%
 - 2nd generation = SFF 86/89%
 - 3rd generation = Proto scratch 99+%
- T-Accuracy under investigation
 - Current ‘capability’ $\pm 10^{\circ}\text{C}$
 - With several calibration algorithm modifications, and a A/C algorithm optimization, an accuracy of $\pm 3^{\circ}\text{C}$ is feasible
- Next steps
 - Further evaluate 3rd generation
 - Improve T-calibration / Accuracy
 - Design Validation

PRESSURE OUTPUT



Typical Pressure Accuracy – based on average 2200 production parts

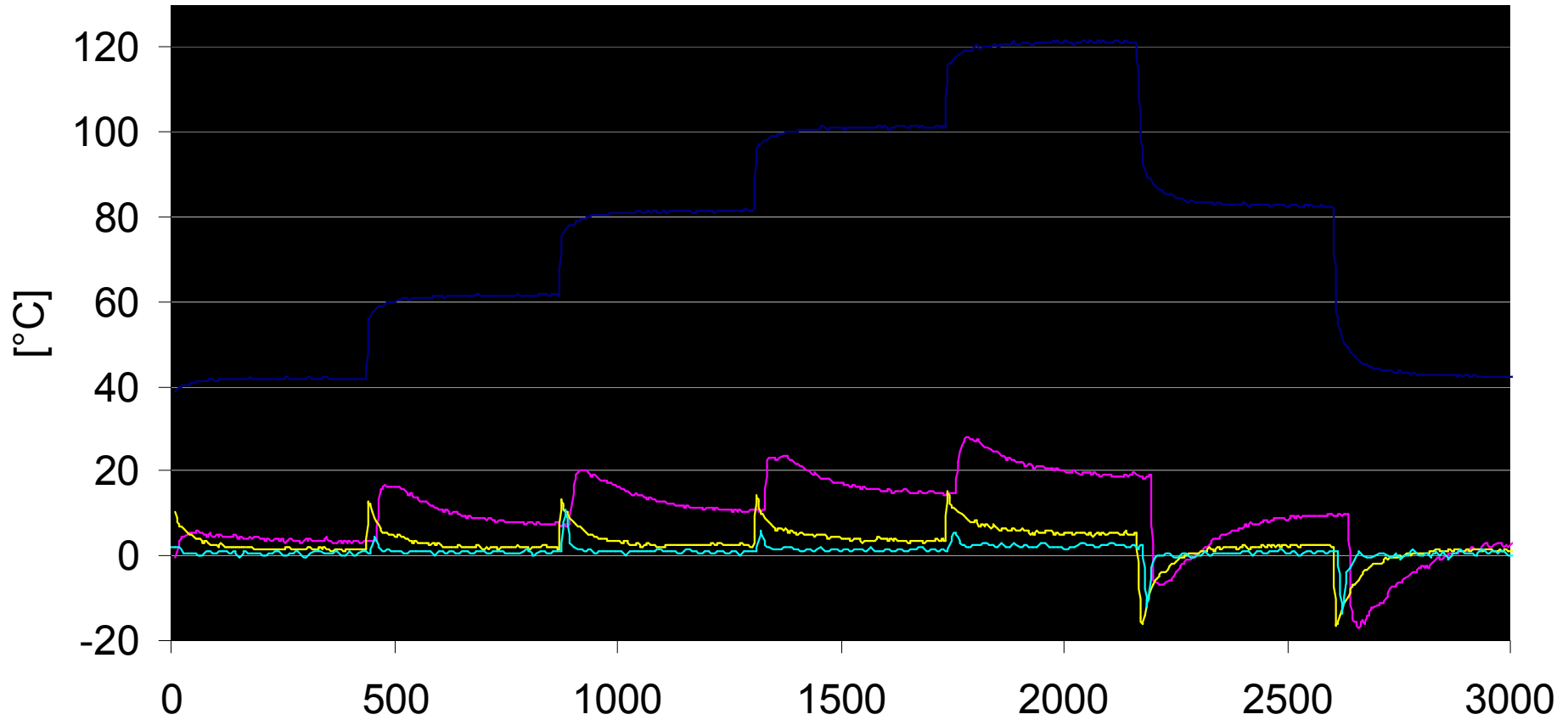
TEMPERATURE OUTPUT



Note: T signal faster than DAQ

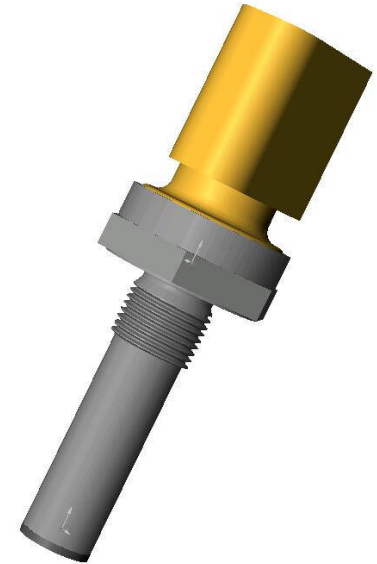
TEMPERATURE OUTPUT

Deviation MSG P&T



PT PROJECT

- 3rd Gen A evaluation February 2002
- P/T: Concept freeze 1Q03
- A sample capability 2Q03



Milestones MSG P+T

Milestone	Due	Note
A-samples	Apr-03	
B sample Tooling release	Apr-03	Customer commitment Estimate,
B-samples	Sep-03	limited production tools
C-sample Tooling Release	Nov-03	
Process development	Jul-04	
C-samples	Sep-04	
PPAP	Jun-05	

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- Thank you for the attention!